

Features

- Reverse mount 0805 package
- Viewing Angle = $\pm 70^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright White
- RoHS compliance

Applications

- Optical indicator.
- Switch and Symbol Display.

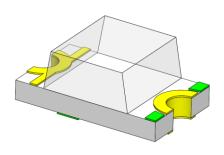
Description

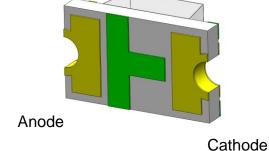
The WP201208-DRC3 is an AllnGaN White LED housed in a miniature SMD package.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs

Package Outline





Schematic

Cathode
$$\longrightarrow$$
 Anode $(-)$



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
I _{FP}	Peak Forward Current	60	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	°C	2
P _D	Power Dissipation at(or below) 25°C Free Air Temperature	95	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol Parameters		Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =2mA	90	-	180	mcd	3
θ1/2	Angle of Half Intensity	I _F =2mA	-	±70	-	deg	

Electrical Characteristics

Symbol Parameters		Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =2mA	2.6	-	3.0	V	4
I _R	Reverse Current	V _R =5V	-	-	1	μΑ	

Notes:

- 1. I_{FP} Conditions--Pulse Width≦ 100µs and Duty≦ 10%.
- 2. Soldering time ≤ 10 seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition	
p1	90	120			
p2	120	150	mcd	$I_F=2mA$	
р3	150	180			

Tolerance of: Luminous Intensity $\pm 10\%$



4. Bin Range of Forward Voltage

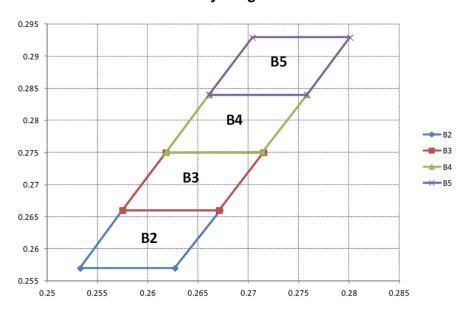
Bin Code	Min	Max	Unit	Condition	
33	2.6	2.7			
34	2.7	2.8	V	I _F =2mA	
35	2.8	2.9	V		
36	2.9	3.0			

Tolerance of Forward Voltage ± 0.05 V.

5. Bin Range of Chromaticity Coordinates

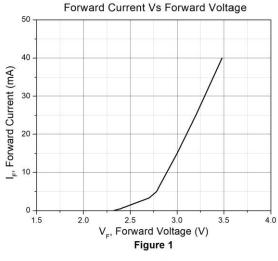
Bin Code	CIE_x	CIE_y	Bin Code	CIE_x	CIE_y
	0.2533	0.2570	В3	0.2575	0.2660
B2	0.2575	0.2660		0.2618	0.2750
DZ	0.2672	0.2660		0.2715	0.2750
	0.2627	0.2570		0.2671	0.2660
	0.2618	0.2750	D.	0.2661	0.2840
B4	0.2661	0.2840		0.2704	0.2929
D4	0.2758	0.2840	B5	0.2801	0.2929
	0.2714	0.2751		0.2758	0.2840

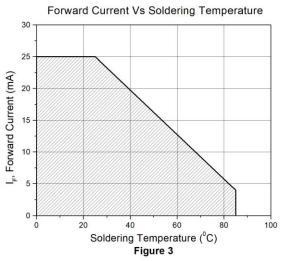
The C.I.E. 1931 Chromaticity Diagram

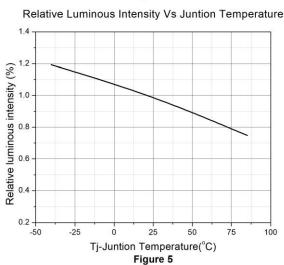


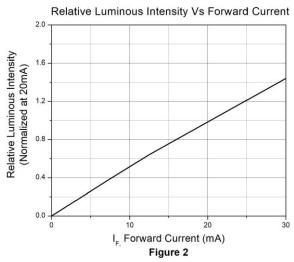


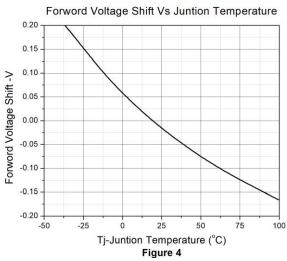
Typical Characteristic Curves

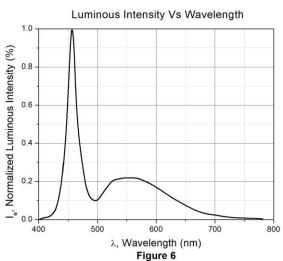






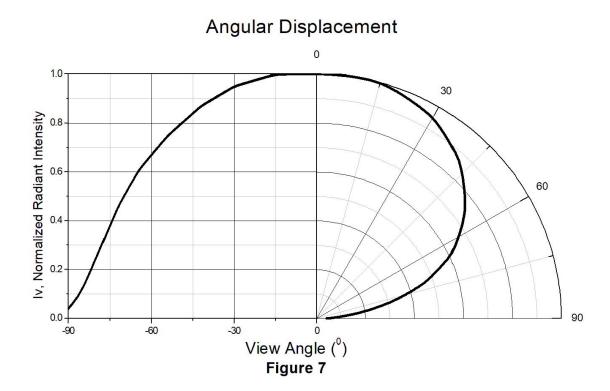






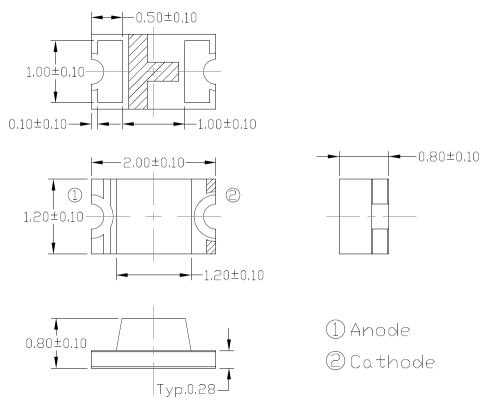


Typical Characteristic Curves



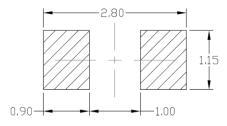


Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



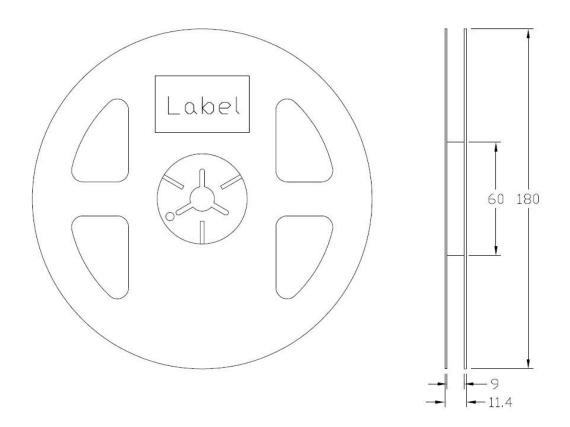
Note: Tolerance unless mentioned is ±0.1mm.

Ordering Information

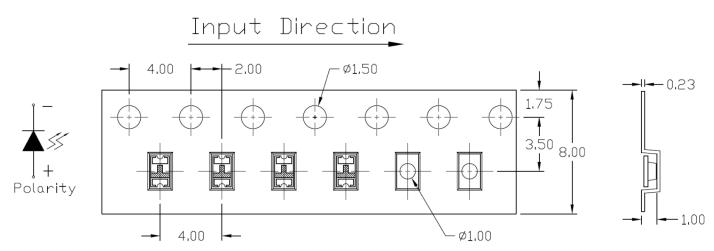
Part Number	Description	Quantity
WP201208-DRC3	Tape & Reel	3000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



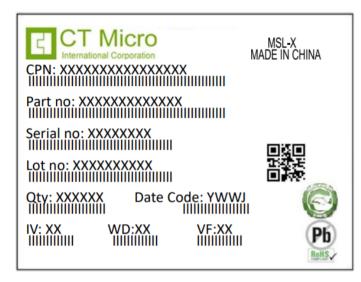
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD: Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

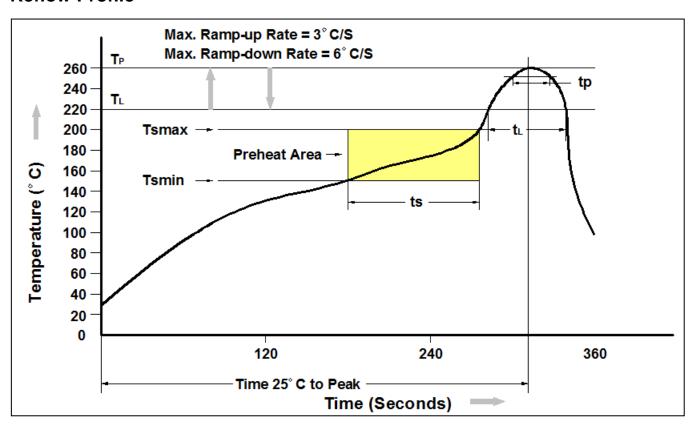
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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